

SF25GZ51, SF25JZ51

MEDIUM POWER CONTROL APPLICATIONS

Unit: mm

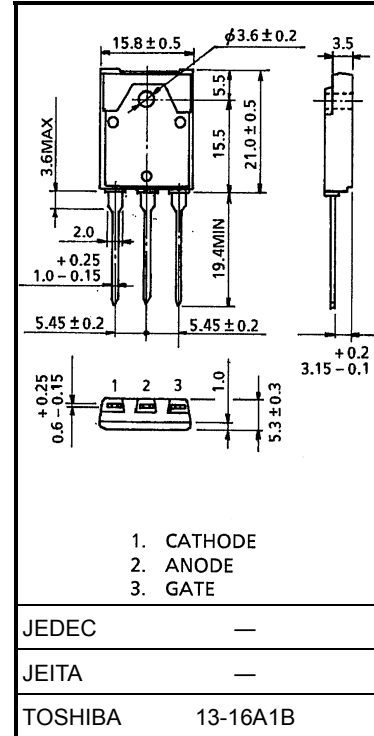
- Repetitive Peak Off-State Voltage: $V_{DRM} = 400V, 600 V$
Repetitive Peak Reverse Voltage: $V_{RRM} = 400V, 600 V$
- Average On-State Current: $I_T (AV) = 25 A$
- Isolation Voltage: $V_{Isol} = 1500 V AC$

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Repetitive Peak Off-State Voltage and Repetitive Peak Reverse Voltage	SF25GZ51	400	V
	SF25JZ51	600	
Non-Repetitive Peak Reverse Voltage (Non-Repetitive < 5 ms, $T_j = 0 \sim 125^\circ C$)	SF25GZ51	500	V
	SF25JZ51	720	
Average On-State Current (Half Sine Waveform)	$I_T (AV)$	25	A
R.M.S On-State Current	$I_T (RMS)$	39	A
Peak One Cycle Surge On-State Current (Non-Repetitive)	I_{TSM}	350 (50 Hz)	A
		385 (60 Hz)	
$I^2 t$ Limit Value	$I^2 t$	612	$A^2 s$
Critical Rate of Rise of On-State Current (Note)	di / dt	100	$A / \mu s$
Peak Gate Power Dissipation	P_{GM}	5	W
Average Gate Power Dissipation	$P_G (AV)$	0.5	W
Peak Forward Gate Voltage	V_{FGM}	10	V
Peak Reverse Gate Voltage	V_{RGM}	-5	V
Peak Forward Gate Current	I_{GM}	2	A
Junction Temperature	T_j	-40~125	$^\circ C$
Storage Temperature Range	T_{stg}	-40~125	$^\circ C$
Isolation Voltage (AC, $t = 1 \text{ min.}$)	V_{Isol}	1500	V

Note : di / dt Test Condition

$i_G = 30mA, t_{gw} = 10\mu s, t_{gr} \leq 250ns$

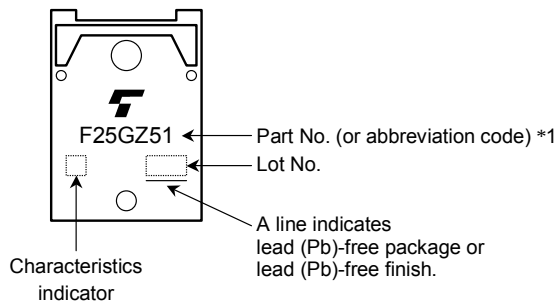


Weight: 5.9 g (typ.)

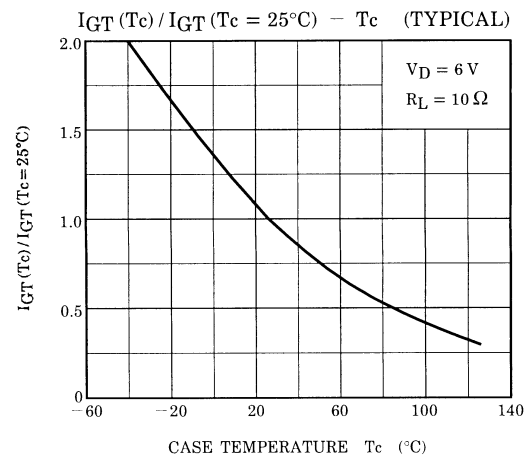
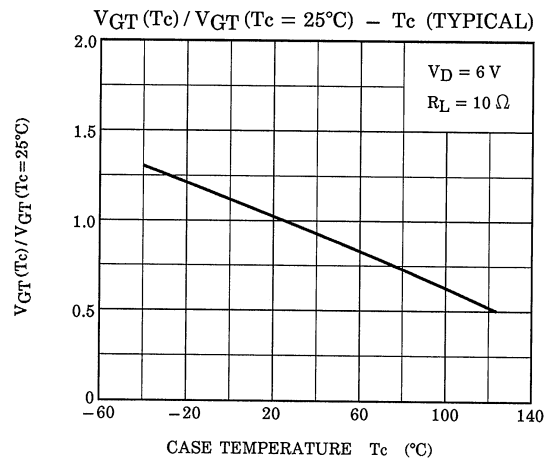
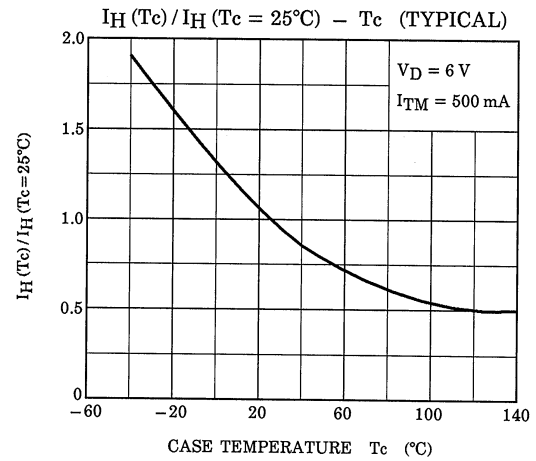
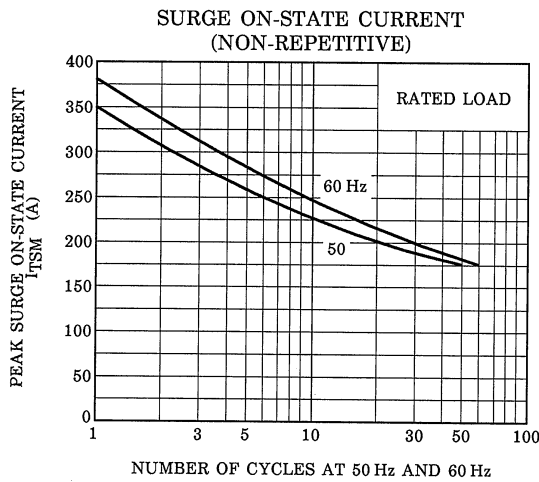
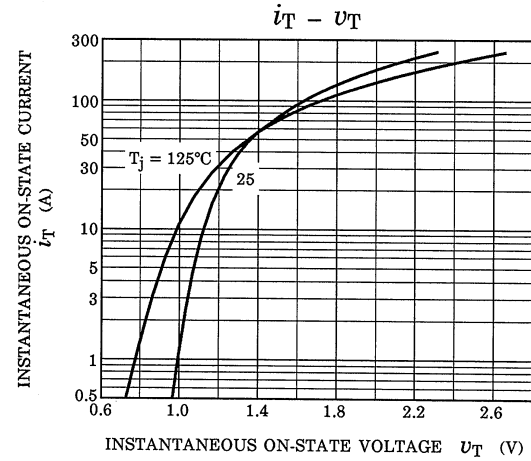
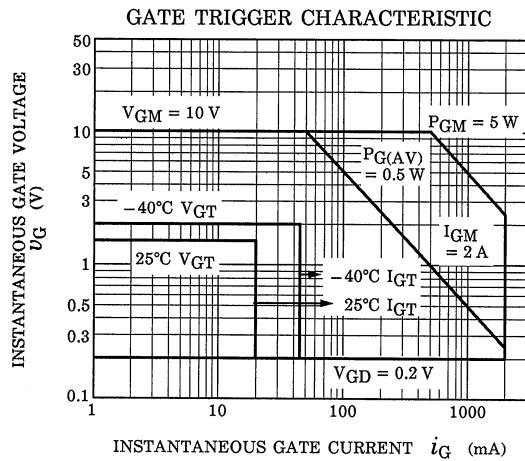
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

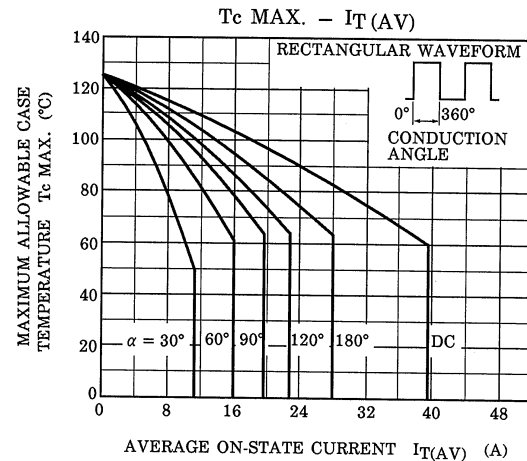
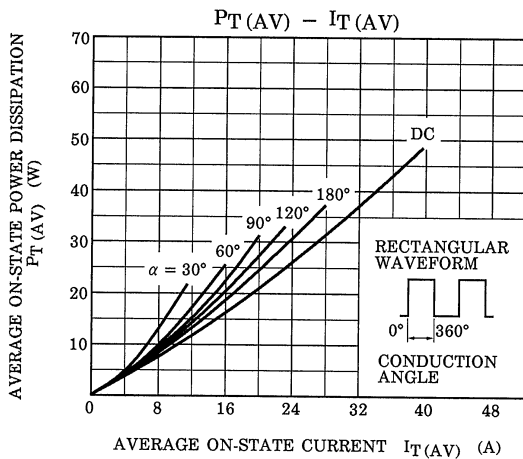
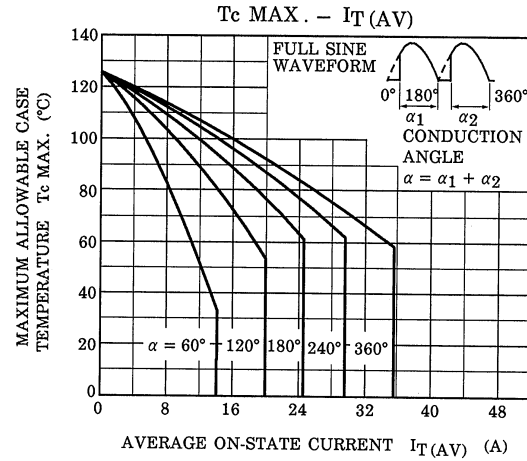
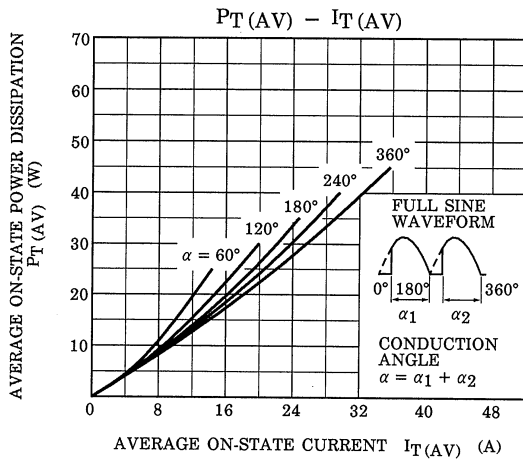
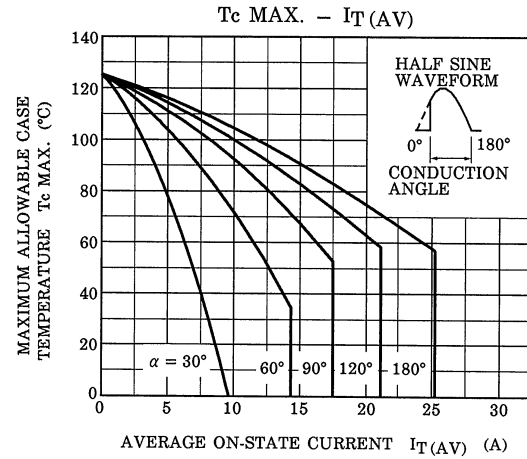
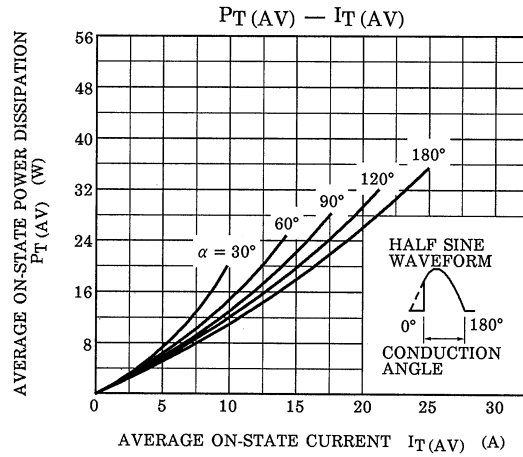
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Repetitive Peak Off-State Current and Repetitive Peak Reverse Current	I_{DRM} I_{RRM}	$V_{DRM} = V_{RRM} = \text{Rated}$	—	—	20	μA
Peak On-State Voltage	V_{TM}	$I_{TM} = 80 \text{ A}$	—	—	1.5	V
Gate Trigger Voltage	V_{GT}	$V_D = 6 \text{ V}, R_L = 10 \Omega$	—	—	1.5	V
Gate Trigger Current	I_{GT}		—	—	20	mA
Holding Current	I_H	$V_D = 6 \text{ V}, I_{TM} = 500 \text{ mA}$	—	—	100	mA
Critical Rate of Rise of Off-State Voltage	dv / dt	$V_{DRM} = \text{Rated}, T_c = 125^\circ\text{C}$ Exponential Rise	—	50	—	V / μs
Thermal Resistance	$R_{th(j-c)}$	Junction to Case	—	—	1.3	$^\circ\text{C} / \text{W}$

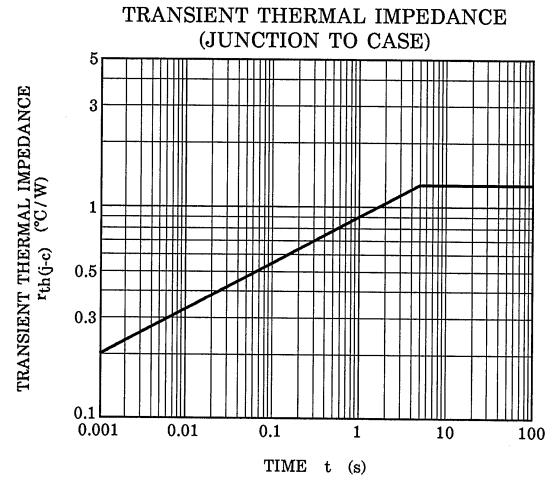
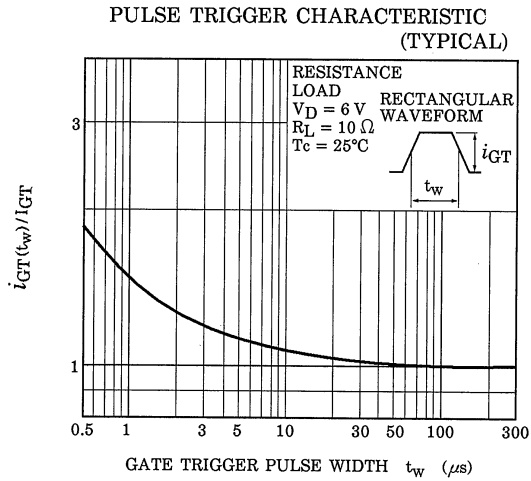
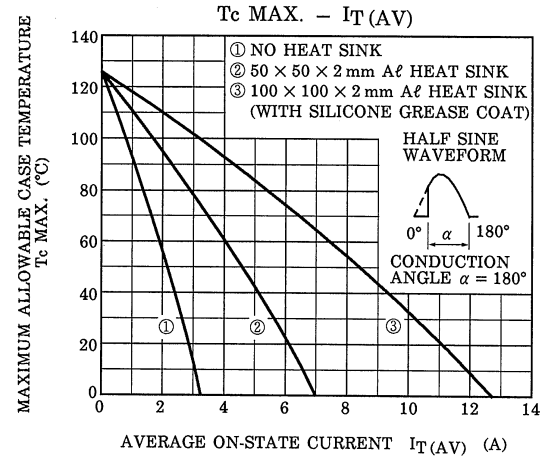
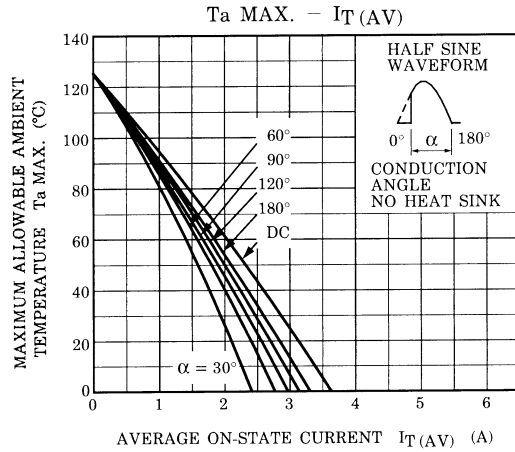
MARKING



*1	Part No. (or abbreviation code)	Part No.
	F25GZ51	SF25GZ51
	F25JZ51	SF25JZ51







RESTRICTIONS ON PRODUCT USE

030619EAA

- The information contained herein is subject to change without notice.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of TOSHIBA or others.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- TOSHIBA products should not be embedded to the downstream products which are prohibited to be produced and sold, under any law and regulations.